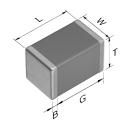
## 积层贴片陶瓷片式电容器

## C2012CH1H332J125AA

RoHS Reach Halogen Free Pb Free

交货型号	C2012CH1H332JT****
用途	一般等级
特点	General 一般(~75V)
系列	C2012 [EIA 0805]
状态	▲ 量产体制(新设计非推荐)



	尺寸
长度(L)	$2.00 \text{mm} \pm 0.20 \text{mm}$
宽度(W)	$1.25$ mm $\pm 0.20$ mm
厚度(T)	$1.25$ mm $\pm 0.20$ mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.50mm Min.
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)
1世存/杆益/11/回 (FM)	0.90mm to 1.20mm(Reflow Soldering)
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)
]世存/杆血/印/印 (LD)	0.70mm to 0.90mm(Reflow Soldering)
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)
7世代が土地が1979(4)5)	0.90mm to 1.20mm(Reflow Soldering)

电·	气特性
电容	$3.3 \text{nF} \pm 5\%$
额定电压	50VDC
温度特性	CH(0±60ppm/° C)
Q (Min.)	1000
绝缘电阻 (Min.)	10000MΩ

	其他	
焊接方法	流体	
<b>汗</b> 依万亿	回流	
AEC-Q200	NO	
包装形式	塑封编带(180mm卷筒)	
包装个数	2000pcs	

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

RoHS Reach Halogen Free Pb Free



特性图表(这是参考数据,并不保证产品的特性。)

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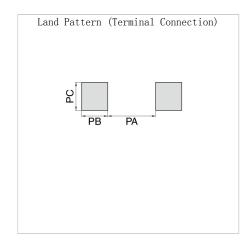
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## Associated Images



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